MA3J142A (MA142A), MA3J142K (MA142K)

Silicon epitaxial planar type

For switching circuits

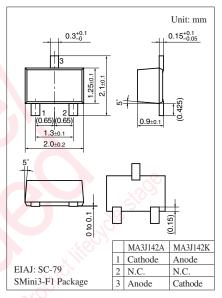
■ Features

- Allowing high-density mounting
- Short reverse recovery time t_{rr}
- Small terminal capacitance C_t

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	V_R	80	V
Maximum peak reverse voltage	V_{RM}	80	V
Forward current	I_{F}	100	mA
Peak forward current	I _{FM}	225	mA
Non-repetitive peak forward	I_{FSM}	500	mA
surge current *			
Junction temperature	T_{j}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

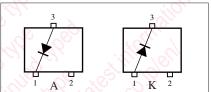
Note) *: t = 1 s



Marking Symbol:

MA3J142A: MB
 MA3J142K: MI

Internal Connection

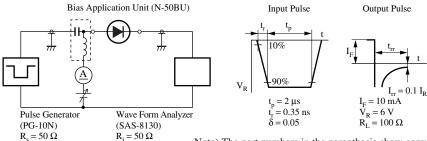


■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage		$V_{\rm F}$	$I_F = 100 \text{ mA}$	0,0	5.	1.2	V
Reverse voltage		V_R	$I_R = 100 \ \mu A$	80			V
Reverse current		I_R	$V_R = 75 \text{ V}$			100	nA
Terminal capacitance	MA3J142A	C _t	$V_R = 0 V, f = 1 MHz$			15	pF
	MA3J142K		10 10 10 10 10 10 10 10 10 10 10 10 10 1			2	
Reverse recovery time *	MA3J142A	t _{rr}	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$			10	ns
	MA3J142K		$I_{rr} = 0.1 I_R, R_L = 100 \Omega$			3	

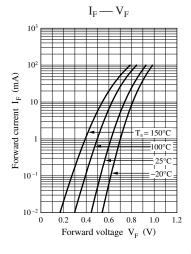
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

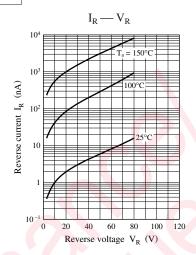
- 2. Absolute frequency of input and output is 100 MHz.
- 3. *: t_{rr} measurement circuit

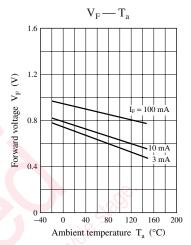


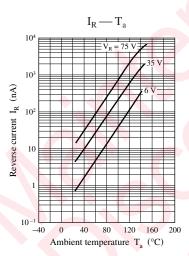
Note) The part numbers in the parenthesis show conventional part number.

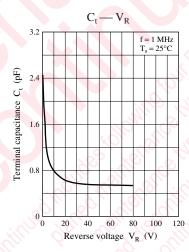
Characteristics charts of MA3J142A

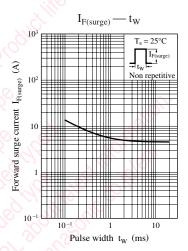








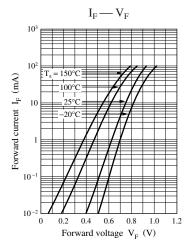


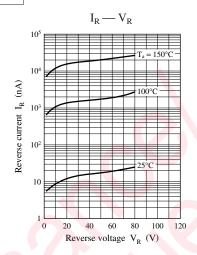


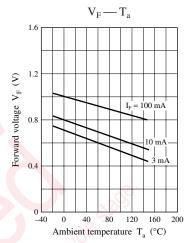
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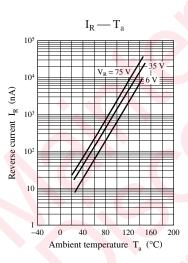
Panasonic

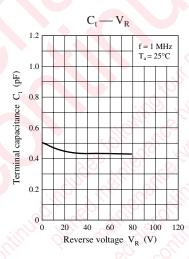
Characteristics charts of MA3J142K

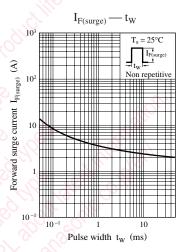












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